

COMMON MODE INDUCTORS

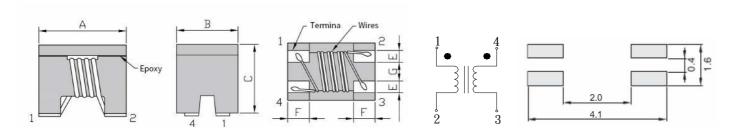
- EF4P3225ER SERIES



•FEATURE

- 1. Ideal for use as common-mode chokes
- 2. Same as TDK ACT1210 type
- Applications
- 1. CAN-BUS, FAXs, modems, ISDNs, etc
- Shape and Dimension

Schematics and Land Patterns(mm)



 $A=3.2\pm0.20 \text{m/m} \; ; \; B=2.5\pm0.20 \; ; \; C=2.50 \text{m/m Max.} \; ; \\ E=0.5 \text{m/m TYP.} \; ; \; F=0.5 \text{m/m TYP.} \; ; \; G=0.50 \text{m/m TYP.} \; . \\$

Specification

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PART NO.	Common Mode INDUCTANCE (uH) (+50%/-30%)	Rated Current (mA)	Rated Voltage (Vdc)	Insulation Resistance (M ohm)	Withstand Voltage (Vdc)	DC Resistance (max.) (ohm)
EF4P3225ER-110	11uH at 100KHz	300	80	10 min	125	0.4
EF4P3225ER-220	22uH at 100KHz	250	80	10 min	125	0.5
EF4P3225ER-510	51uH at 100KHz	200	80	10 min	125	0.7
EF4P3225ER-101	100uH at 100KHz	150	80	10 min	125	1.5

Note1. Measurement ambient temperature of electrical: at 20°C

Note2. Test equipment: HP4291B



GENERAL CHARACTERISTICS

- 1. Operating temperature range: -40 TO + 105°C (Includes temperature when the coil is heated)
- 2. External appearance: On visual inspection, the coil has no external defects.
- 3. Terminal strength: After soldering. Between copper plate and terminals of coil. Push in two directions of X.Y withstanding at below conditions.
 - Terminal should not peel off. (refer to figure at right) 0.5kg Min -EF4P3225L.
- 4. Insulating resistance: Over 100MΩ at 100V D.C. between coil and core.
- 5. Dielectric strength: No dielectric breakdown at 100V D.C. for 1 minute between coil and core.
- 6. Temperature characteristics: Inductance coefficient (0~2,000)x10-6/°C (-25~+80°C).
- 7. Humidity characteristics(Moisture Resistance): Inductance deviation within ±5%, after 96 hours in 90~95% relative humidity at 40 ±2°C and 1 hour drying under normal condition.
- 8. Vibration resistance: Inductance deviation within ±5%, after vibration for 1 hour. In each of three orientations at sweep vibration (10~55~10 Hz) with 1.5mm P-P amplitudes.
- 9. Shock resistance: Inductance deviation within ±5%, after being dropped once with 981m/s2 (100G) shock attitude upon a rubber block method shock testing machine, in three different orientations.
- 10. Resistance to Soldering Heat: 260°C, 10 seconds(See attached recommend reflow)
- 11. Storage condition: Temperature Range: 0° C ~ 35° C ; - 40° C ~ 105° C (after PCB) , Humidity Range: 50° ~ 70% RH
- 12. Use components within 12 months. If 12 months or more have elapsed, check solderability before use.
- 13. Reflow profile recommend:

Lead-free heat endurance test

Lead-free the recommended reflow condition

